



# Characterization, Optimization and Analysis of 200 Gbps Communication Channels

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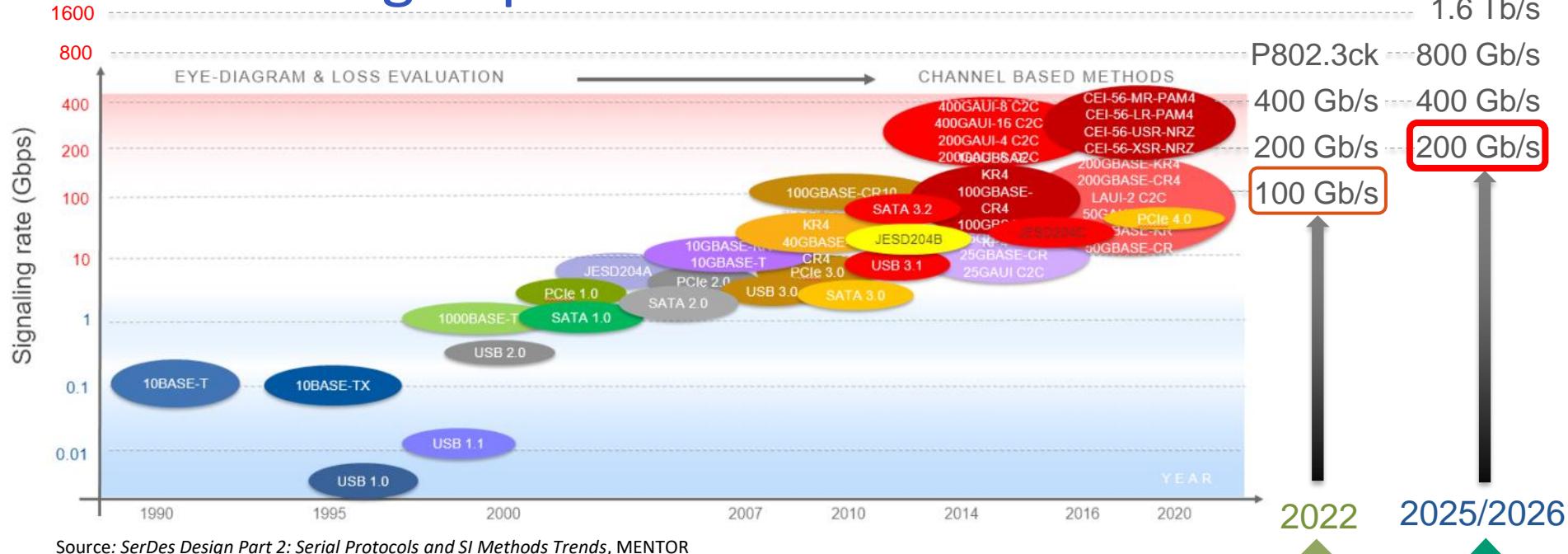
Villasimius - 12 giugno 2025

# Acknowledgements

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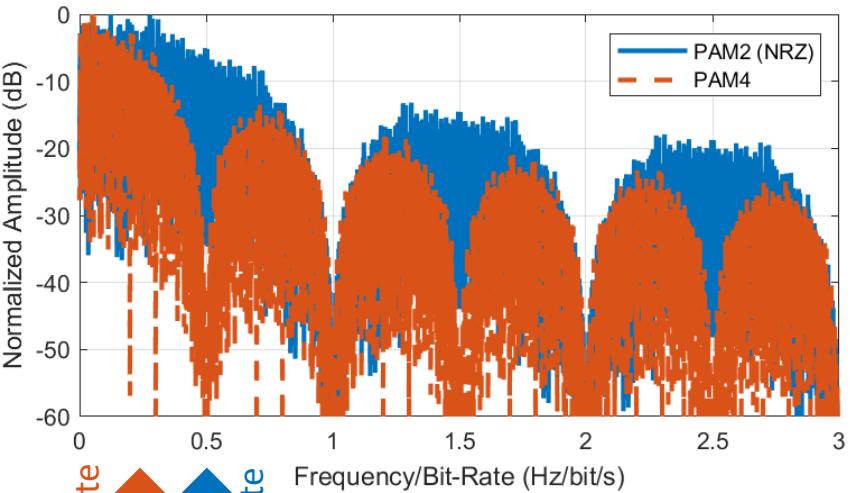
# High Speed Serial Link Evolution



Source: SerDes Design Part 2: Serial Protocols and SI Methods Trends, MENTOR

- **IEEE 802.3ck (106Gbps)**: Electrical C2M & C2C & CR1 & KR1 400GbE
- **OIF CEI-112G-VSR-PAM4 (112Gbps)**: Very Short Reach Interface
- **IEEE 802.3df\* (212Gbps)**: New PAR: Electrical 800 Gb/s and 1.6 Tb/s over copper
- **OIF CEI-224G (224Gbps)**: New OIF Project at White-Paper start

# Introduction to PAM4



## PAM4 advantages:

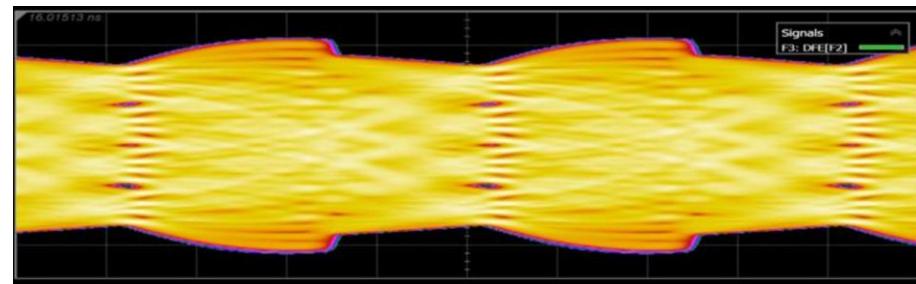
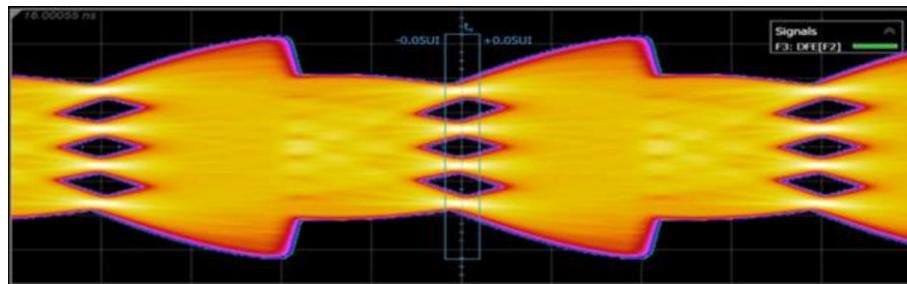
- Double bit rate:
  - Bit-rate<sub>NRZ</sub> = symbol rate (Gb/s=Gbaud)
  - Bit-rate<sub>PAM4</sub> = 2×symbol rate (i.e. 28 Gbaud = 56 Gb/s)
- or, half Nyquist (fundam.) frequency

$$f_{\text{Nyquist}} = \frac{1}{4} \text{ Bit-Rate}$$

	PAM 4	NRZ
Bits for UI	2	1
Levels	4	2
Rising/Falling edges	6/6	1/1
Transitions	12	2
Eye per UI	3	1

# Data Rate vs. Eye Diagram

Increasing data rate ( $> 200$  Gbps): larger bandwidth, shorter  $t_r/t_f$  ( $\approx 3-4$  ps), tight UI ( $\approx 9.4$  ps)



Degradation of performances:  
stronger impact of jitter, noise, losses, crosstalk, ISI

Possible solutions involving:

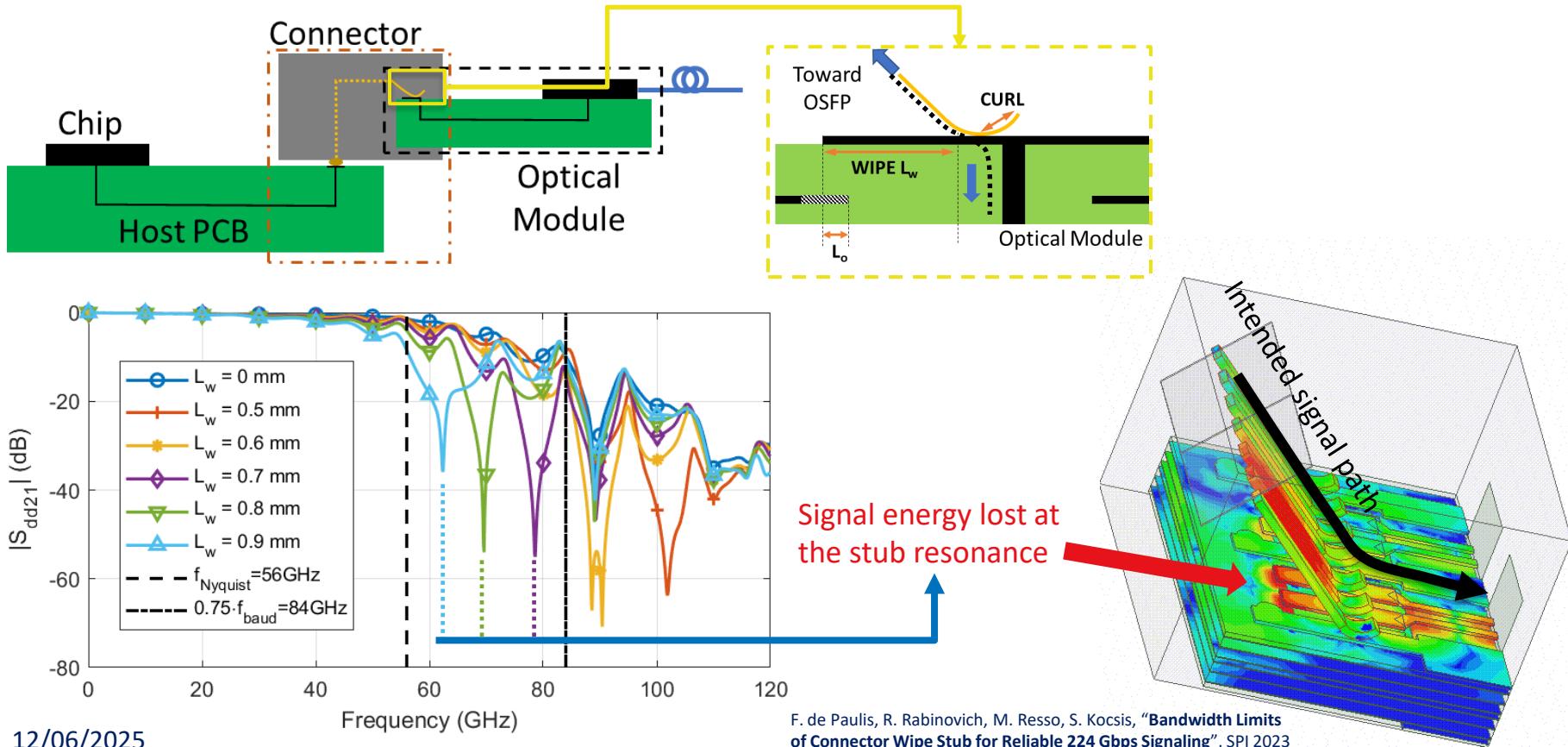
More complex equalization, better manufacturing (materials, assembly, tolerances)

# Outline

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- Physical Design and Challenges
- Channel Equalization
- The Channel Operating Margin (COM) Method
- Verification at 212 Gbps
- Future Trends and Conclusions

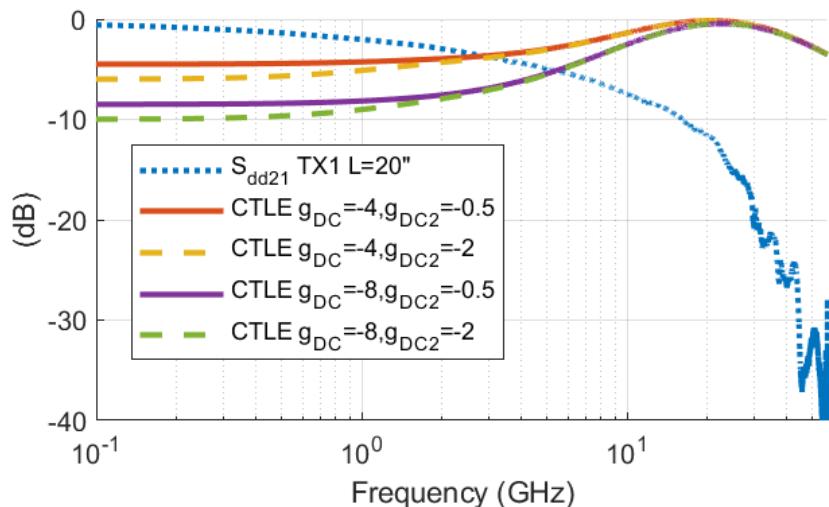
# Mated Connector (OSFP, QSFP-DD)



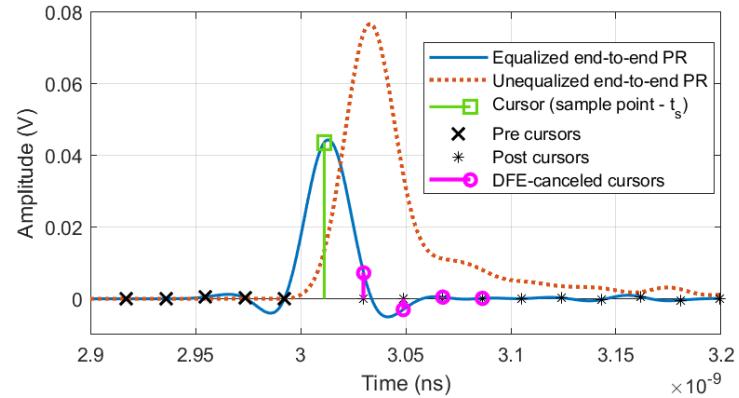
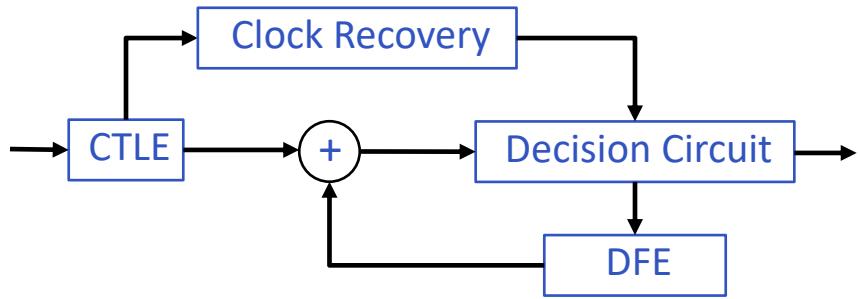
# Equalization (at RX)

## Continuous Time Linear Equalizer (CTLE)

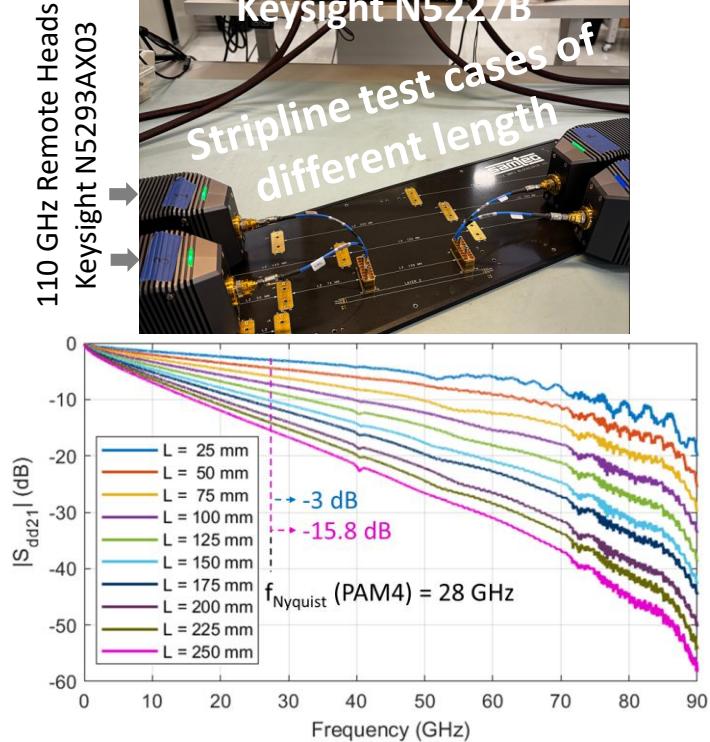
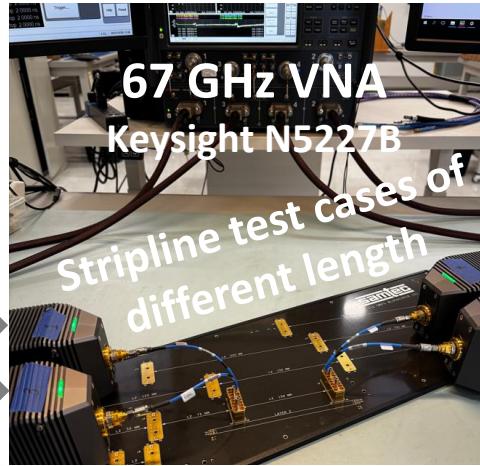
$$H_{CTLE}(f) = \frac{\left(10^{\frac{g_{DC}}{20}} + j\frac{f}{f_z}\right)\left(10^{\frac{g_{DC2}}{20}} + j\frac{f}{f_{LF}}\right)}{\left(1 + j\frac{f}{f_{p1}}\right)\left(1 + j\frac{f}{f_{p2}}\right)\left(1 + j\frac{f}{f_{LF}}\right)}$$



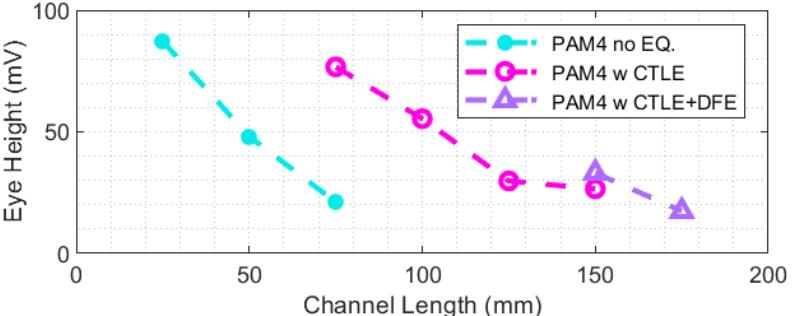
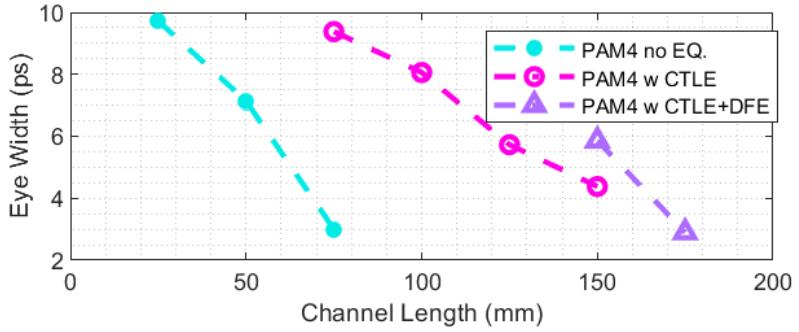
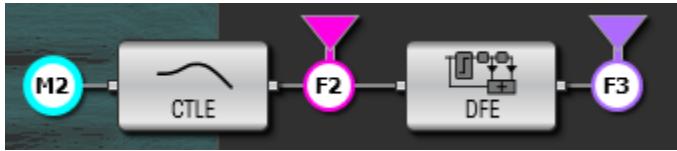
## Decision Feedback Equalizer (DFE)



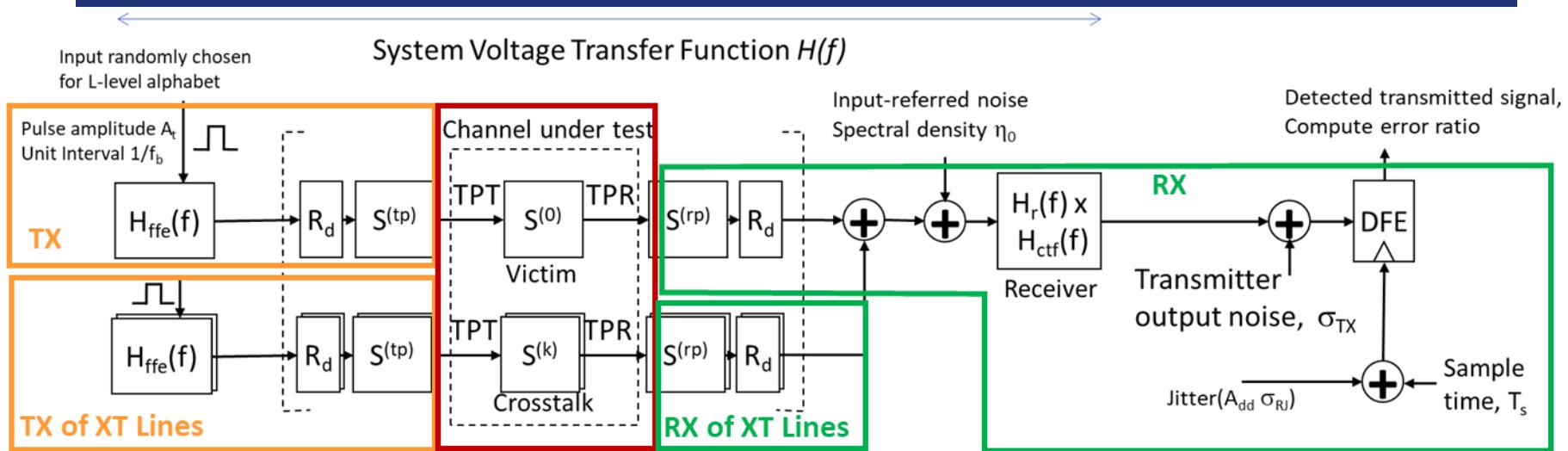
# Example (at 112 Gbps PAM4)



Waveform  
PRBS at RX



# Channel Design and Optimization: COM

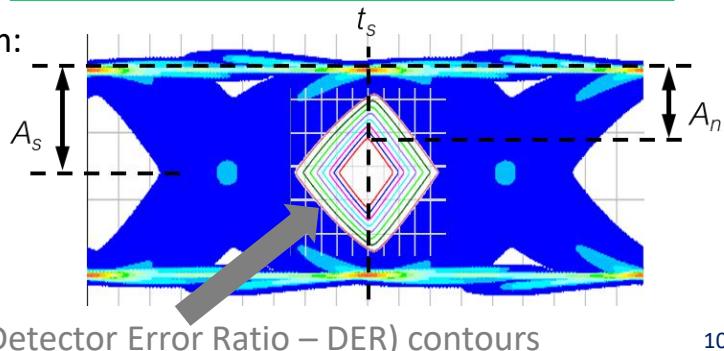


The COM metric comes out from the **Channel Operating Margin** algorithm:

$$COM = 20 \log \frac{A_s}{A_n}$$

Amplitude of signal obtained by the maximization of FOM

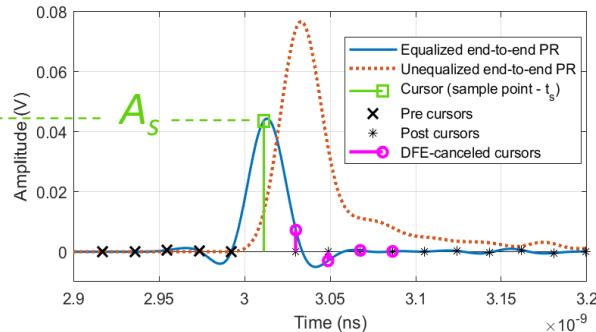
Combined amplitude of noise and interference (crosstalk) at a given DER value



# The COM Algorithm

$A_s$  obtained by maximization of **FOM** through a full-search of equalization parameters (FFE, CTLE, DFE):

$$FOM = 20 \log \frac{\left( h^{(0)}(t_s) \right)^2}{\sigma_{TX}^2 + \sigma_{ISI}^2 + \sigma_J^2 + \sigma_{XT}^2 + \sigma_N^2}$$

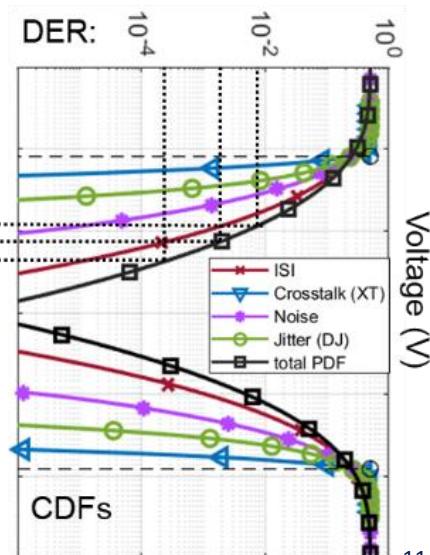
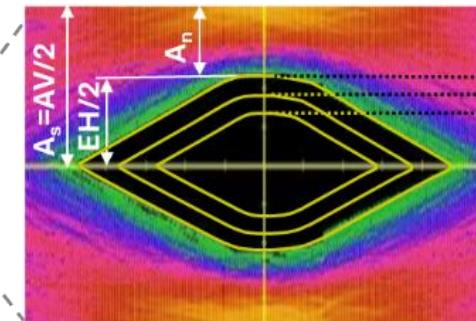
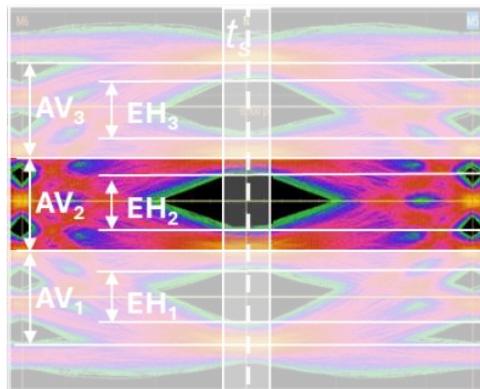


— Computed  
 - Given (Input)

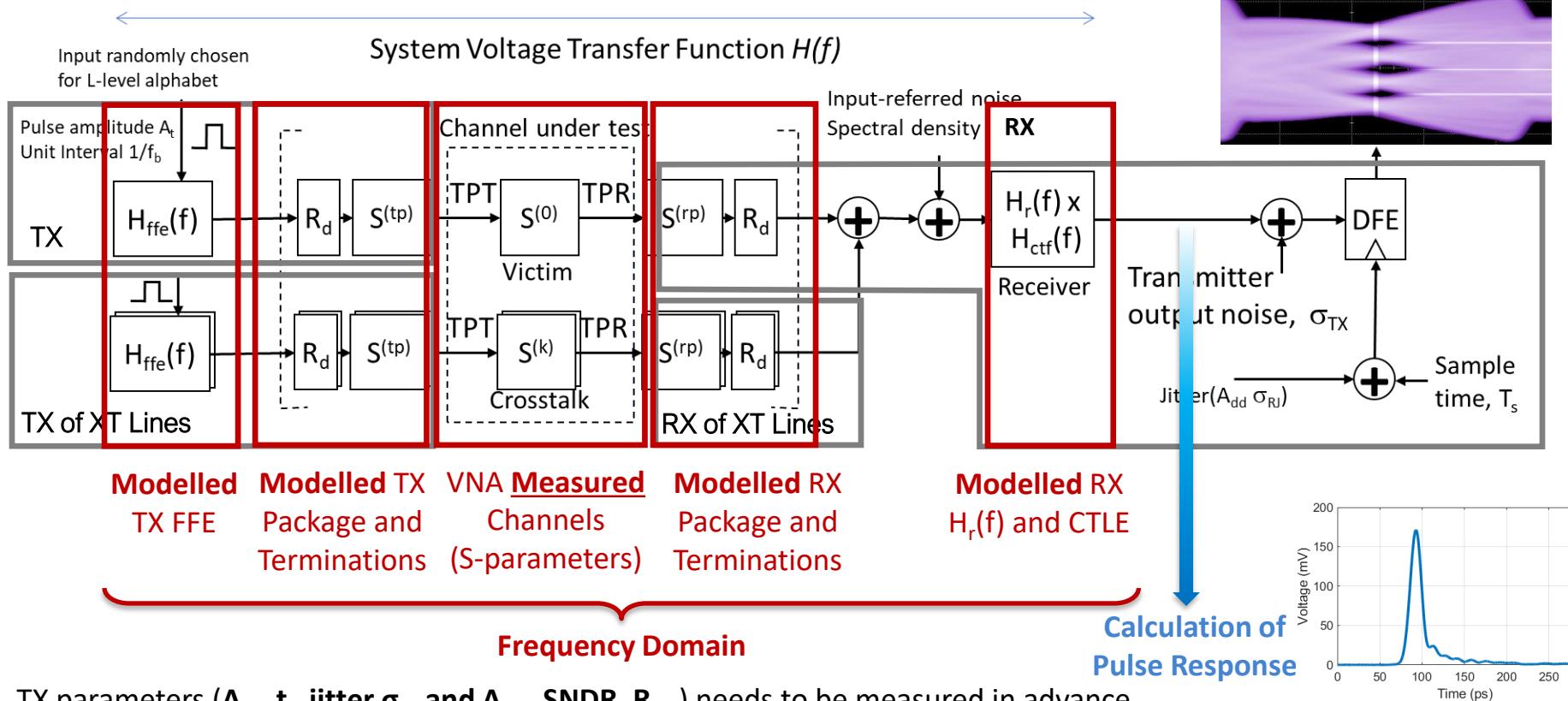
Combination, by convolution, of PDFs associated to all noise contributions:

An alternative metric from 802.3ck:  
**Vertical Eye Closure**

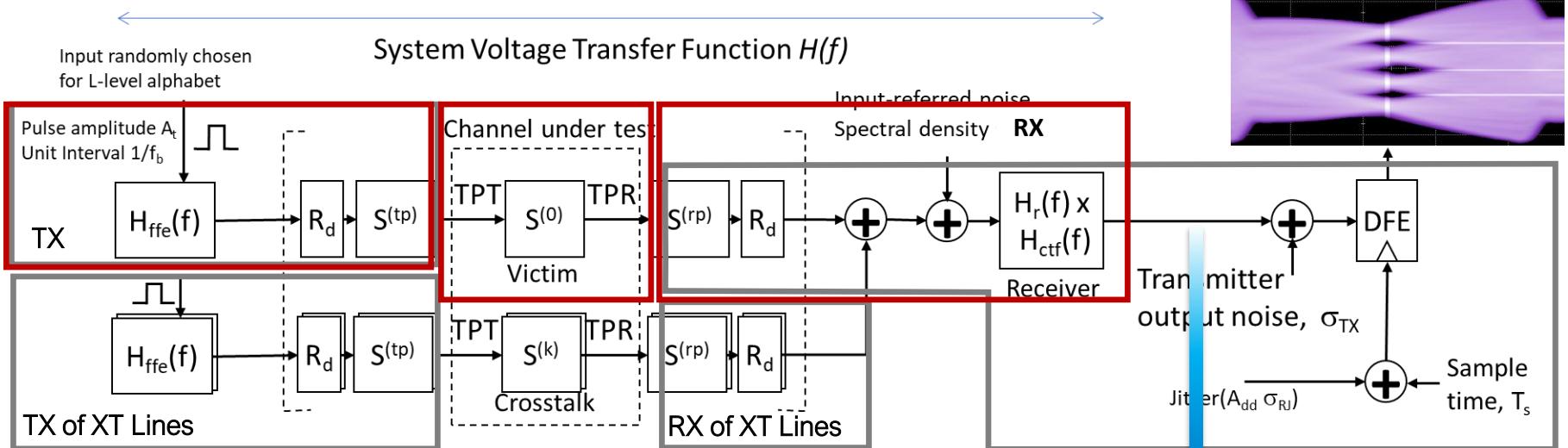
$$VEC = \min \left( 20 \log \frac{AV_i}{EH_i} \right)$$



# The COM Algorithm in Frequency Domain



# PR-Based COM Algorithm (Time Domain)



## Hardware TX:

Instrumentation or  
Silicon source

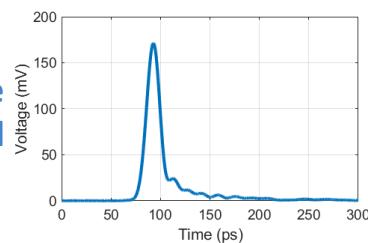
## Channel

## Instrumentation RX:

$H_r(f)$ , w/wo CTLE

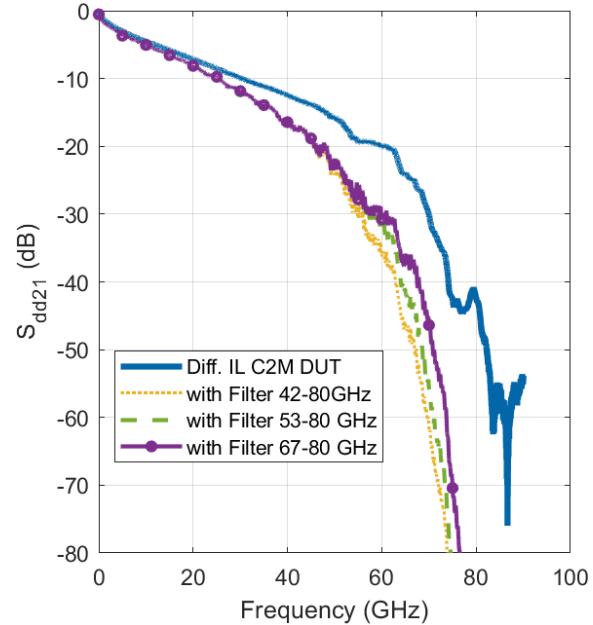
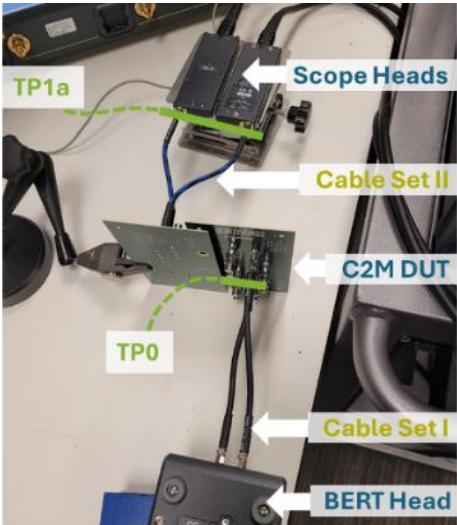
Several assumptions for FD-COM set uncertainties that are not acceptable for time domain conversion while moving toward the edge of applicability of the method for  $> 200$  Gbps

Extraction of  
Pulse Response  
from Measured  
PRBS13Q  
Waveform

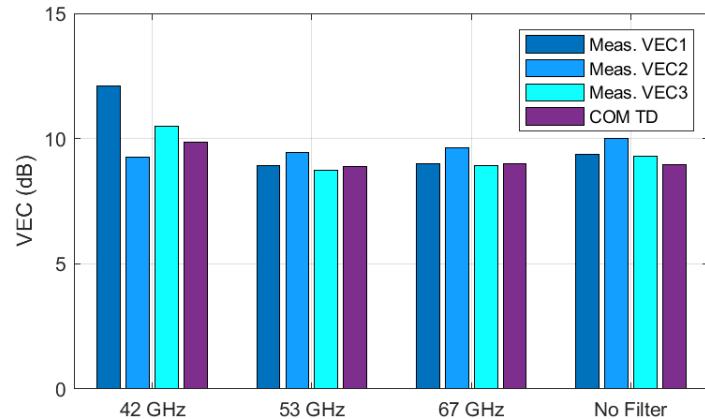
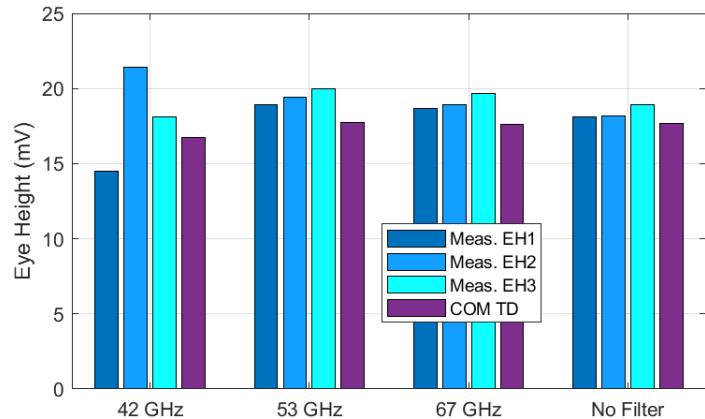


# Verification of COM at 212.5 Gbps

DUT (PCB + Conn + PCB) representative of expected C2M interface losses @  $f_{\text{Nyquist}}$

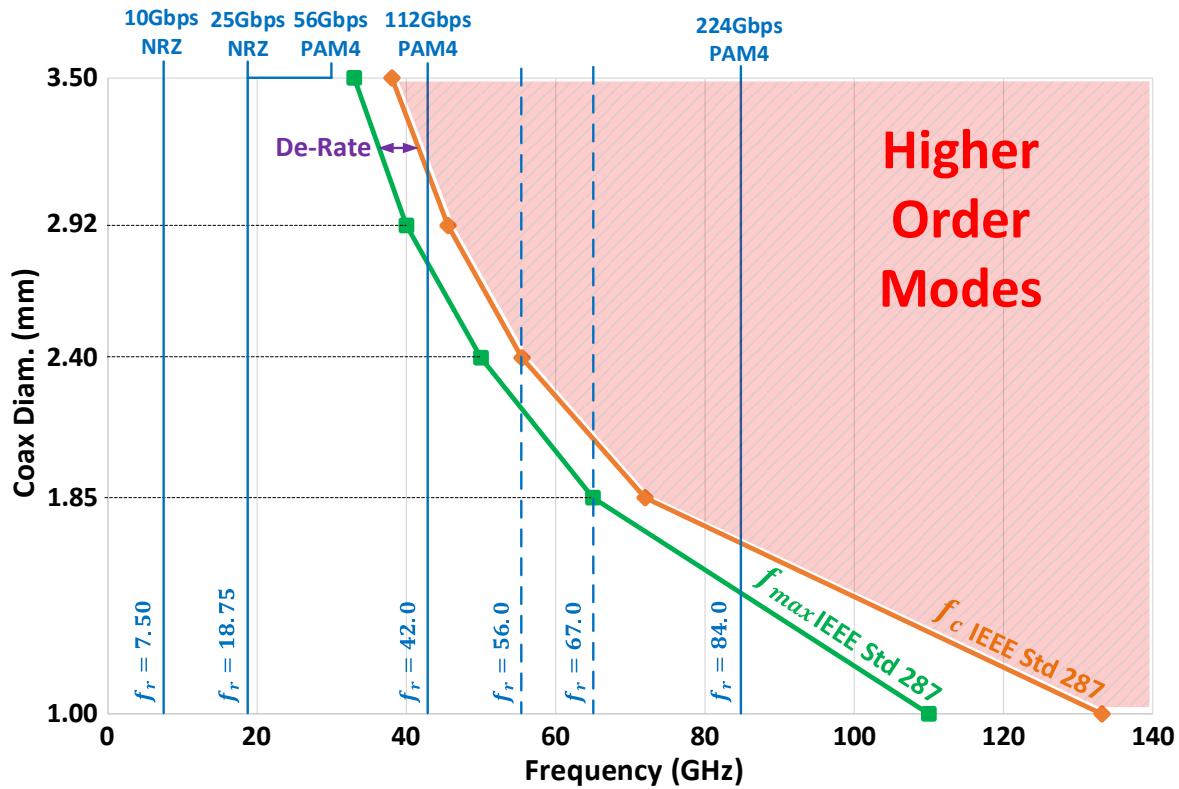


Experimental setup fully equipped with 1.00 mm interfaces

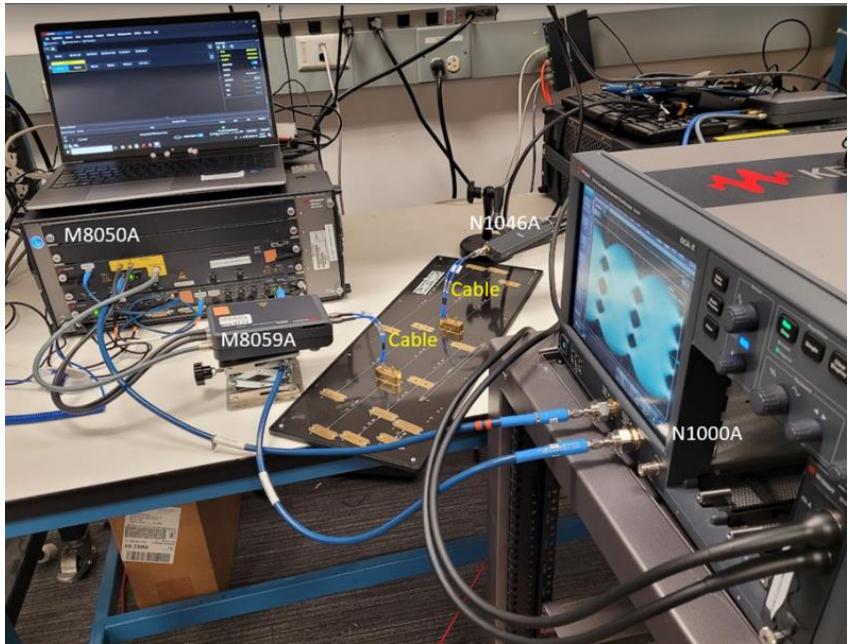


# Testability

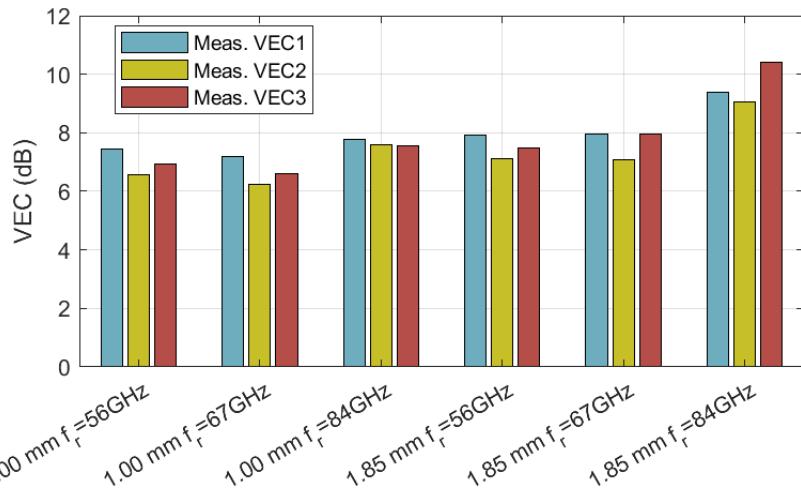
- IEEE Std 287 modal cutoff frequencies ( $f_c$ ) from mechanical interface specification
- De-rated ( $f_{max}$ ) for margin and interoperability per coax connector diameter
- Butterworth filter cutoff ( $f_r$ ) traditionally 1.5x fundamental frequency for signaling rates 112 Gbps



# Uncertainties by 1.00 mm vs 1.85 mm Setups



B. Gore, R. Mellitz, A. Josephson, F. de Paulis, L. Boluna, J. Calvin, Rabinovich, M. Resso,  
"Are 1.0 mm Precision RF Connectors Really Required for 224 Gbps-PAM4 Verification?",  
DesignCon 2024.



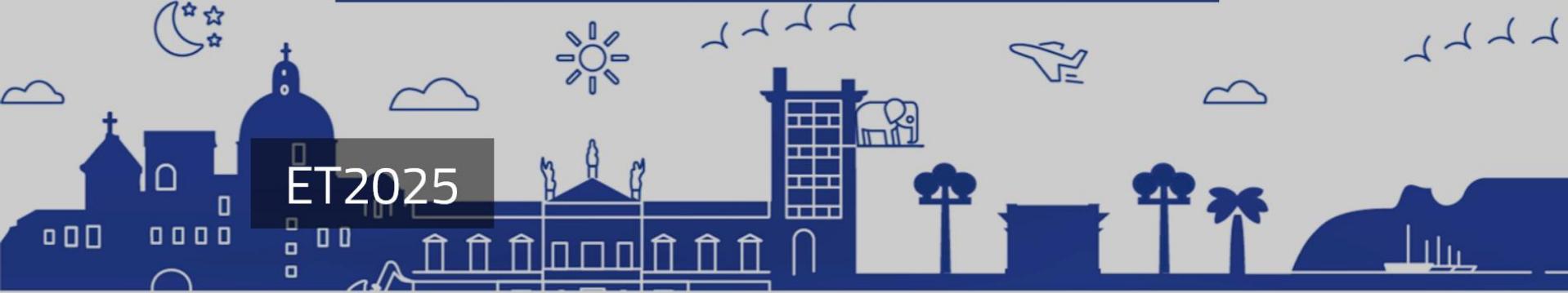
- A 4<sup>th</sup> order Butterworth filter is applied  $f_r$  (@ -3dB) = 56, 67, 84 GHz
- Both 1.0 mm and 1.85 mm cases show little VEC difference for  $f_r = 56, 67$  GHz
- Worst VEC for the 1.85 mm setup

# Conclusions

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- The feasibility and design process of communication rates above 200 Gbps for short channels of C2M type are demonstrated
- Technological limits set by the 100 Gbps previous data rate generation are successfully overcome by investigating new solutions for channel design, optimization, and testing for 200 Gbps signaling
- Such solutions that may be taken into account toward the definition of the next Ethernet and OIF Standards foreseen for late 2025 (or in 2026)
- The 400 Gbps are under the radar screen of major technology players targeting the best trade-off among modulation scheme (i.e. PAM6), channel BW (to be kept < 100 GHz)

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# Thank you